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## REVISION HISTORY

### 3/16—Rev. B to Rev. C

|                                  |            |
|----------------------------------|------------|
| Changed LFCSP_VQ to LFCSP .....  | Throughout |
| Changes to Figure 3.....         | 8          |
| Updated Outline Dimensions ..... | 15         |
| Changes to Ordering Guide .....  | 15         |

### 2/09—Rev. A to Rev. B

|  |    |
|--|----|
| Changes to Power Requirements, $I_{DD}$ , Digital Inputs = 5 V |    |
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| Updated Outline Dimensions .....                               | 15 |

### 7/06—Rev. 0 to Rev. A

|   |           |
|---|-----------|
| Updated Format.....                     | Universal |
| Changes to Table 1.....                 | 3         |
| Changes to Table 2.....                 | 5         |
| Changes to the Terminology Section..... | 14        |

### 7/05—Revision 0: Initial Version

## SPECIFICATIONS

## DUAL SUPPLY

$V_{DD} = 15\text{ V} \pm 10\%$ ,  $V_{SS} = -15\text{ V} \pm 10\%$ , GND = 0 V, unless otherwise noted.

Table 1.

| Parameter  | Y Version <sup>1</sup> |                |                                    | Unit    | Test Conditions/Comments   |
|--|------------------------|----------------|------------------------------------|---------|--|
|  | 25°C                   | –40°C to +85°C | –40°C to +125°C                    |         |  |
| ANALOG SWITCH  |                        |                |                                    |         |  |
| Analog Signal Range                                      |                        |                | V <sub>DD</sub> to V <sub>SS</sub> | V       |  |
| On Resistance (R <sub>ON</sub> )                         | 120                    |                |                                    | Ω typ   | V <sub>S</sub> = ±10 V, I <sub>S</sub> = –1 mA; see Figure 21                    |
|  | 190                    | 230            | 260                                | Ω max   | V <sub>DD</sub> = +13.5 V, V <sub>SS</sub> = –13.5 V                             |
| On Resistance Match Between Channels (ΔR <sub>ON</sub> ) | 3.5                    |                |                                    | Ω typ   | V <sub>S</sub> = ±10 V, I <sub>S</sub> = –1 mA                                   |
|  | 6                      | 10             | 12                                 | Ω max   |  |
| On Resistance Flatness (R <sub>FLAT(ON)</sub> )          | 20                     |                |                                    | Ω typ   | V <sub>S</sub> = –5 V, 0 V, +5 V; I <sub>S</sub> = –1 mA                         |
|  | 57                     | 72             | 79                                 | Ω max   |  |
| LEAKAGE CURRENTS   |                        |                |                                    |         |  |
| Source Off Leakage, I <sub>S</sub> (OFF)                 | ±0.02                  |                |                                    | nA typ  | V <sub>DD</sub> = +16.5 V, V <sub>SS</sub> = –16.5 V                             |
|  | ±0.1                   | ±0.6           | ±1                                 | nA max  | V <sub>S</sub> = ±10 V, V <sub>D</sub> = ∓10 V; see Figure 22                    |
| Drain Off Leakage, I <sub>D</sub> (OFF)                  | ±0.02                  |                |                                    | nA typ  | V <sub>S</sub> = ±10 V, V <sub>D</sub> = ∓10 V; see Figure 22                    |
|  | ±0.1                   | ±0.6           | ±1                                 | nA max  |  |
| Channel On Leakage, I <sub>D</sub> , I <sub>S</sub> (ON) | ±0.02                  |                |                                    | nA typ  | V <sub>S</sub> = V <sub>D</sub> = ±10 V; see Figure 23                           |
|  | ±0.2                   | ±0.6           | ±1                                 | nA max  |  |
| DIGITAL INPUTS   |                        |                |                                    |         |  |
| Input High Voltage, V <sub>INH</sub>                     |                        |                | 2.0                                | V min   |  |
| Input Low Voltage, V <sub>INL</sub>                      |                        |                | 0.8                                | V max   |  |
| Input Current, I <sub>INL</sub> or I <sub>INH</sub>      | 0.005                  |                |                                    | μA typ  | V <sub>IN</sub> = V <sub>INL</sub> or V <sub>INH</sub>                           |
|  |                        |                | ±0.1                               | μA max  |  |
| Digital Input Capacitance, C <sub>IN</sub>               | 2.5                    |                |                                    | pF typ  |  |
| DYNAMIC CHARACTERISTICS <sup>2</sup>                     |                        |                |                                    |         |  |
| Transition Time, t <sub>TRANS</sub>                      | 120                    |                |                                    | ns typ  | R <sub>L</sub> = 300 Ω, C <sub>L</sub> = 35 pF                                   |
|  | 150                    | 180            | 200                                | ns max  | V <sub>S</sub> = 10 V; see Figure 24   |
| t <sub>ON</sub> (EN)                                     | 70                     |                |                                    | ns typ  | R <sub>L</sub> = 300 Ω, C <sub>L</sub> = 35 pF                                   |
|  | 85                     | 100            | 110                                | ns max  | V <sub>S</sub> = 10 V; see Figure 26   |
| t <sub>OFF</sub> (EN)                                    | 90                     |                |                                    | ns typ  | R <sub>L</sub> = 300 Ω, C <sub>L</sub> = 35 pF                                   |
|  | 110                    | 135            | 155                                | ns max  | V <sub>S</sub> = 10 V; see Figure 26   |
| Break-Before-Make Time Delay, t <sub>D</sub>             | 25                     |                |                                    | ns typ  | R <sub>L</sub> = 300 Ω, C <sub>L</sub> = 35 pF                                   |
|  |                        |                | 10                                 | ns min  | V <sub>S1</sub> = V <sub>S2</sub> = 10 V; see Figure 25                          |
| Charge Injection   | –0.7                   |                |                                    | pC typ  | V <sub>S</sub> = 0 V, R <sub>S</sub> = 0 Ω, C <sub>L</sub> = 1 nF; see Figure 27 |
| Off Isolation  | 85                     |                |                                    | dB typ  | R <sub>L</sub> = 50 Ω, C <sub>L</sub> = 5 pF, f = 1 MHz; see Figure 28           |
| Channel-to-Channel Crosstalk                             | 80                     |                |                                    | dB typ  | R <sub>L</sub> = 50 Ω, C <sub>L</sub> = 5 pF, f = 1 MHz; see Figure 30           |
| Total Harmonic Distortion + Noise                        | 0.15                   |                |                                    | % typ   | R <sub>L</sub> = 10 kΩ, 5 V rms, f = 20 Hz to 20 kHz; see Figure 31              |
| Bandwidth –3 dB  | 800                    |                |                                    | MHz typ | R <sub>L</sub> = 50 Ω, C <sub>L</sub> = 5 pF; see Figure 29                      |
| C <sub>S</sub> (OFF)                                     | 1.2                    |                |                                    | pF typ  | f = 1 MHz, V <sub>S</sub> = 0 V  |
|  | 1.5                    |                |                                    | pF max  | f = 1 MHz, V <sub>S</sub> = 0 V  |
| C <sub>D</sub> (OFF)                                     | 3.6                    |                |                                    | pF typ  | f = 1 MHz, V <sub>S</sub> = 0 V  |
|  | 4.2                    |                |                                    | pF max  | f = 1 MHz, V <sub>S</sub> = 0 V  |
| C <sub>D</sub> , C <sub>S</sub> (ON)                     | 5.5                    |                |                                    | pF typ  | f = 1 MHz, V <sub>S</sub> = 0 V  |
|  | 6.5                    |                |                                    | pF max  | f = 1 MHz, V <sub>S</sub> = 0 V  |

| Parameter          | Y Version <sup>1</sup> |                   |                    | Unit                                   | Test Conditions/Comments                              |
|--------------------|------------------------|-------------------|--------------------|--|---|
|                    | 25°C                   | –40°C to<br>+85°C | –40°C to<br>+125°C |  |   |
| POWER REQUIREMENTS |                        |                   |                    |  | $V_{DD} = +16.5\text{ V}$ , $V_{SS} = -16.5\text{ V}$ |
| $I_{DD}$           | 0.001                  |                   | 1.0                | $\mu\text{A typ}$<br>$\mu\text{A max}$ | Digital inputs = 0 V or $V_{DD}$                      |
| $I_{DD}$           | 170                    |                   | 285                | $\mu\text{A typ}$<br>$\mu\text{A max}$ | Digital inputs = 5 V                                  |
| $I_{SS}$           | 0.001                  |                   | 1.0                | $\mu\text{A typ}$<br>$\mu\text{A max}$ | Digital inputs = 0 V or $V_{DD}$                      |
| $I_{SS}$           | 0.001                  |                   | 1.0                | $\mu\text{A typ}$<br>$\mu\text{A max}$ | Digital inputs = 5 V                                  |

<sup>1</sup> Y version temperature range is –40°C to +125°C.

<sup>2</sup> Guaranteed by design, not subject to production test.

**SINGLE SUPPLY**

$V_{DD} = 12\text{ V} \pm 10\%$ ,  $V_{SS} = 0\text{ V}$ ,  $GND = 0\text{ V}$ , unless otherwise noted.

**Table 2.**

| Parameter  | Y Version <sup>1</sup> |                |                        | Unit    | Test Conditions/Comments   |
|--|------------------------|----------------|------------------------|---------|--|
|  | 25°C                   | –40°C to +85°C | –40°C to +125°C        |         |  |
| ANALOG SWITCH  |                        |                |                        |         |  |
| Analog Signal Range                                      |                        |                | 0 V to V <sub>DD</sub> | V       |  |
| On Resistance (R <sub>ON</sub> )                         | 300                    |                |                        | Ω typ   | V <sub>S</sub> = 0 V to 10 V, I <sub>S</sub> = –1 mA; see Figure 21              |
|  | 475                    | 567            | 625                    | Ω max   | V <sub>DD</sub> = 10.8 V, V <sub>SS</sub> = 0 V                                  |
| On Resistance Match Between Channels (ΔR <sub>ON</sub> ) | 5                      |                |                        | Ω typ   | V <sub>S</sub> = 0 V to 10 V, I <sub>S</sub> = –1 mA                             |
|  | 16                     | 26             | 27                     | Ω max   |  |
| On Resistance Flatness (R <sub>FLAT(ON)</sub> )          | 60                     |                |                        | Ω typ   | V <sub>S</sub> = 3 V, 6 V, 9 V; I <sub>S</sub> = –1 mA                           |
| LEAKAGE CURRENTS   |                        |                |                        |         |  |
| Source Off Leakage, I <sub>S</sub> (OFF)                 | ±0.02                  |                |                        | nA typ  | V <sub>DD</sub> = 13.2 V   |
|  | ±0.1                   | ±0.6           | ±1                     | nA max  | V <sub>S</sub> = 1 V/10 V, V <sub>D</sub> = 10 V/1 V; see Figure 22              |
| Drain Off Leakage, I <sub>D</sub> (OFF)                  | ±0.02                  |                |                        | nA typ  | V <sub>S</sub> = 1 V/10 V, V <sub>D</sub> = 10 V/1 V; see Figure 22              |
|  | ±0.1                   | ±0.6           | ±1                     | nA max  |  |
| Channel On Leakage, I <sub>D</sub> , I <sub>S</sub> (ON) | ±0.02                  |                |                        | nA typ  | V <sub>S</sub> = V <sub>D</sub> = 1 V or 10 V; see Figure 23                     |
|  | ±0.2                   | ±0.6           | ±1                     | nA max  |  |
| DIGITAL INPUTS   |                        |                |                        |         |  |
| Input High Voltage, V <sub>INH</sub>                     |                        |                | 2.0                    | V min   |  |
| Input Low Voltage, V <sub>INL</sub>                      |                        |                | 0.8                    | V max   |  |
| Input Current, I <sub>INL</sub> or I <sub>INH</sub>      | 0.001                  |                |                        | μA typ  | V <sub>IN</sub> = V <sub>INL</sub> or V <sub>INH</sub>                           |
|  |                        |                | ±0.1                   | μA max  |  |
| Digital Input Capacitance, C <sub>IN</sub>               | 2.5                    |                |                        | pF typ  |  |
| DYNAMIC CHARACTERISTICS <sup>2</sup>                     |                        |                |                        |         |  |
| Transition Time, t <sub>TRANS</sub>                      | 150                    |                |                        | ns typ  | R <sub>L</sub> = 300 Ω, C <sub>L</sub> = 35 pF                                   |
|  | 190                    | 240            | 265                    | ns max  | V <sub>S</sub> = 8 V; see Figure 24  |
| t <sub>ON</sub> (EN)                                     | 95                     |                |                        | ns typ  | R <sub>L</sub> = 300 Ω, C <sub>L</sub> = 35 pF                                   |
|  | 120                    | 150            | 170                    | ns max  | V <sub>S</sub> = 8 V; see Figure 26  |
| t <sub>OFF</sub> (EN)                                    | 100                    |                |                        | ns typ  | R <sub>L</sub> = 300 Ω, C <sub>L</sub> = 35 pF                                   |
|  | 125                    | 155            | 170                    | ns max  | V <sub>S</sub> = 8 V; see Figure 26  |
| Break-Before-Make Time Delay, t <sub>D</sub>             | 50                     |                |                        | ns typ  | R <sub>L</sub> = 300 Ω, C <sub>L</sub> = 35 pF                                   |
|  |                        |                | 10                     | ns min  | V <sub>S1</sub> = V <sub>S2</sub> = 8 V; see Figure 25                           |
| Charge Injection   | –0.4                   |                |                        | pC typ  | V <sub>S</sub> = 6 V, R <sub>S</sub> = 0 Ω, C <sub>L</sub> = 1 nF; see Figure 27 |
| Off Isolation  | 85                     |                |                        | dB typ  | R <sub>L</sub> = 50 Ω, C <sub>L</sub> = 5 pF, f = 1 MHz; see Figure 28           |
| Channel-to-Channel Crosstalk                             | 80                     |                |                        | dB typ  | R <sub>L</sub> = 50 Ω, C <sub>L</sub> = 5 pF, f = 1 MHz; see Figure 30           |
| Bandwidth –3 db  | 550                    |                |                        | MHz typ | R <sub>L</sub> = 50 Ω, C <sub>L</sub> = 5 pF; see Figure 29                      |
| C <sub>S</sub> (OFF)                                     | 1.2                    |                |                        | pF typ  | f = 1 MHz; V <sub>S</sub> = 6 V  |
|  | 1.5                    |                |                        | pF max  | f = 1 MHz; V <sub>S</sub> = 6 V  |
| C <sub>D</sub> (OFF)                                     | 3.6                    |                |                        | pF typ  | f = 1 MHz; V <sub>S</sub> = 6 V  |
|  | 4.2                    |                |                        | pF max  | f = 1 MHz; V <sub>S</sub> = 6 V  |
| C <sub>D</sub> , C <sub>S</sub> (ON)                     | 5.5                    |                |                        | pF typ  | f = 1 MHz; V <sub>S</sub> = 6 V  |
|  | 6.5                    |                |                        | pF max  | f = 1 MHz; V <sub>S</sub> = 6 V  |

| Parameter          | Y Version <sup>1</sup> |                   |                    | Unit             | Test Conditions/Comments  |
|--------------------|------------------------|-------------------|--------------------|------------------|---|
|                    | 25°C                   | –40°C to<br>+85°C | –40°C to<br>+125°C |                  |   |
| POWER REQUIREMENTS |                        |                   |                    |                  |   |
| I <sub>DD</sub>    | 0.001                  |                   | 1.0                | μA typ<br>μA max | V <sub>DD</sub> = 13.2 V<br>Digital inputs = 0 V or V <sub>DD</sub> |
| I <sub>DD</sub>    | 170                    |                   | 285                | μA typ<br>μA max | Digital inputs = 5 V  |

<sup>1</sup> Y version temperature range is –40°C to +125°C.

<sup>2</sup> Guaranteed by design, not subject to production test.

## ABSOLUTE MAXIMUM RATINGS

$T_A = 25^\circ\text{C}$ , unless otherwise noted.

Table 3.

| Parameter   | Rating   |
|---|--|
| $V_{DD}$ to $V_{SS}$  | 35 V   |
| $V_{DD}$ to GND   | −0.3 V to +25 V  |
| $V_{SS}$ to GND   | +0.3 V to −25 V  |
| Analog Inputs <sup>1</sup>  | $V_{SS} - 0.3\text{ V}$ to $V_{DD} + 0.3\text{ V}$ or<br>30 mA, whichever occurs first |
| Digital Inputs <sup>1</sup>                                       | GND − 0.3 V to $V_{DD} + 0.3\text{ V}$ or<br>30 mA, whichever occurs first             |
| Peak Current, S or D  | 100 mA (pulsed at 1 ms,<br>10% duty cycle maximum)                                     |
| Continuous Current  | 45 mA  |
| Operating Temperature Range                                       |  |
| Automotive (Y Version)  | −40°C to +125°C  |
| Storage Temperature Range   | −65°C to +150°C  |
| Junction Temperature  | 150°C  |
| 14-Lead TSSOP, $\theta_{JA}$ Thermal<br>Impedance (4-Layer Board) | 112°C/W  |
| 12-Lead LFCSP,<br>$\theta_{JA}$ Thermal Impedance                 | 80°C/W   |
| Reflow Soldering Peak<br>Temperature, Pb Free                     | 260°C  |

<sup>1</sup> Overvoltages at IN, S, or D are clamped by internal diodes. Current must be limited to the maximum ratings given.

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

Only one absolute maximum rating can be applied at any one time.

### ESD CAUTION



#### ESD (electrostatic discharge) sensitive device.

Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS

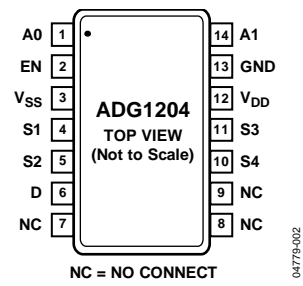
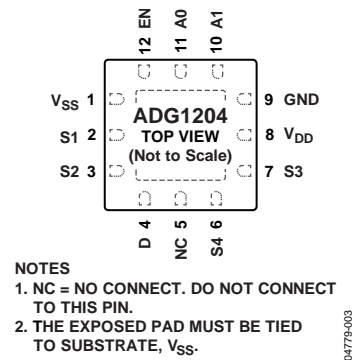


Figure 2. TSSOP Pin Configuration



NOTES  
1. NC = NO CONNECT. DO NOT CONNECT TO THIS PIN.  
2. THE EXPOSED PAD MUST BE TIED TO SUBSTRATE, VSS.  
Figure 3. LFCSP Pin Configuration

Table 4. Pin Function Descriptions

| Pin No. |       | Mnemonic | Description   |
|---------|-------|----------|---|
| TSSOP   | LFCSP |          |   |
| 1       | 11    | A0       | Logic Control Input.  |
| 2       | 12    | EN       | Active High Digital Input. When low, the device is disabled and all switches are off. When high, Ax logic inputs determine on switches. |
| 3       | 1     | VSS      | Most Negative Power Supply Potential.   |
| 4       | 2     | S1       | Source Terminal. Can be an input or an output.  |
| 5       | 3     | S2       | Source Terminal. Can be an input or an output.  |
| 6       | 4     | D        | Drain Terminal. Can be an input or an output.   |
| 7 to 9  | 5     | NC       | No Connection.  |
| 10      | 6     | S4       | Source Terminal. Can be an input or an output.  |
| 11      | 7     | S3       | Source Terminal. Can be an input or an output.  |
| 12      | 8     | VDD      | Most Positive Power Supply Potential.   |
| 13      | 9     | GND      | Ground (0 V) Reference.   |
| 14      | 10    | A1       | Logic Control Input.  |

TRUTH TABLE

Table 5.

| EN | A1 | A0 | S1  | S2  | S3  | S4  |
|----|----|----|-----|-----|-----|-----|
| 0  | X  | X  | Off | Off | Off | Off |
| 1  | 0  | 0  | On  | Off | Off | Off |
| 1  | 0  | 1  | Off | On  | Off | Off |
| 1  | 1  | 0  | Off | Off | On  | Off |
| 1  | 1  | 1  | Off | Off | Off | On  |

## TYPICAL PERFORMANCE CHARACTERISTICS

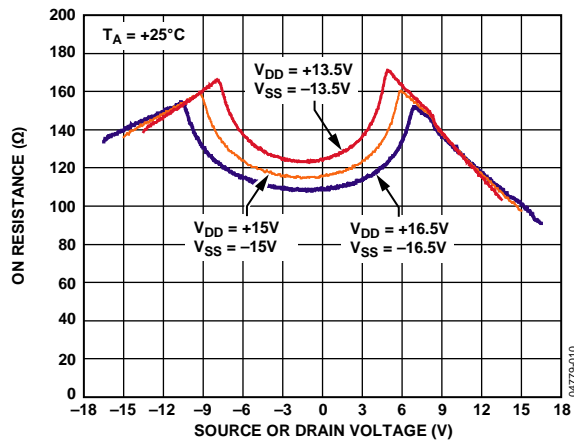
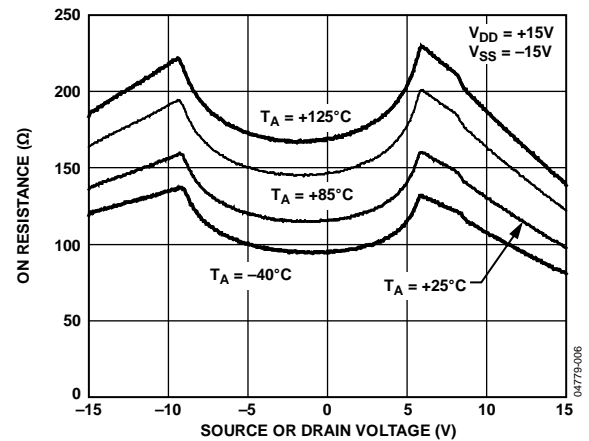
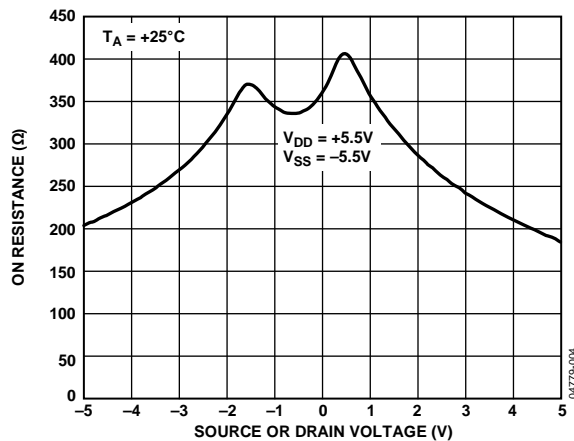
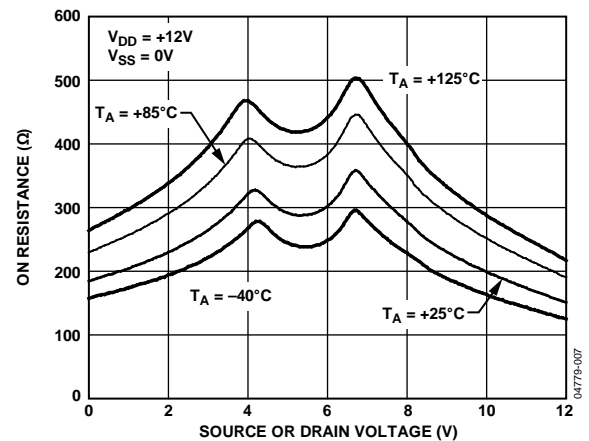
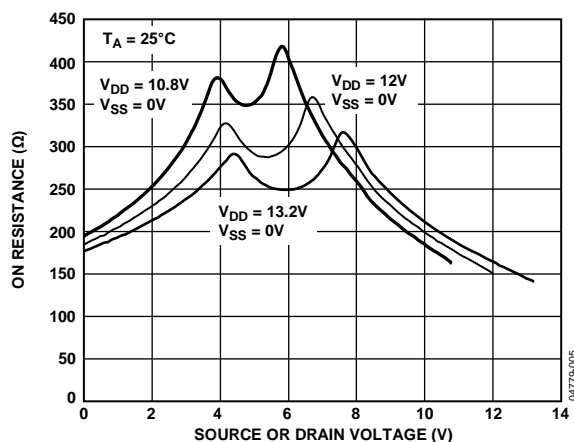
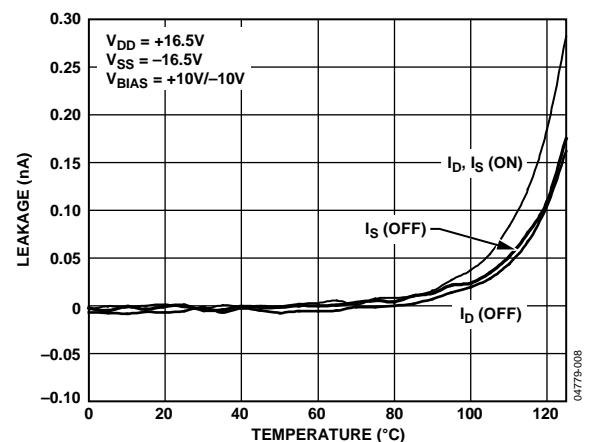
Figure 4. On Resistance as a Function of  $V_D$  ( $V_S$ ), Dual SupplyFigure 7. On Resistance as a Function of  $V_D$  ( $V_S$ ) for Different Temperatures, Dual SupplyFigure 5. On Resistance as a Function of  $V_D$  ( $V_S$ ), Dual SupplyFigure 8. On Resistance as a Function of  $V_D$  ( $V_S$ ) for Different Temperatures, Single SupplyFigure 6. On Resistance as a Function of  $V_D$  ( $V_S$ ), Single Supply

Figure 9. Leakage Currents as a Function of Temperature, Dual Supply



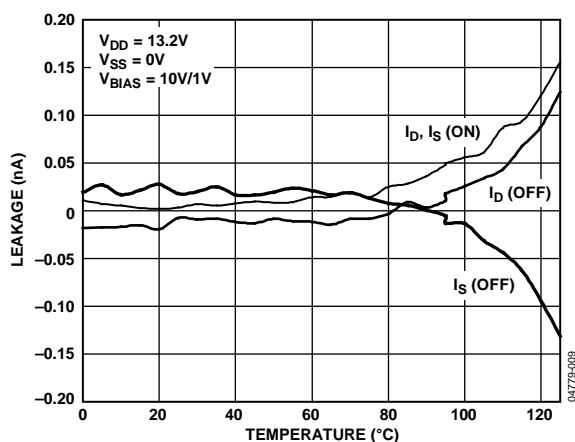


Figure 10. Leakage Currents as a Function of Temperature, Single Supply

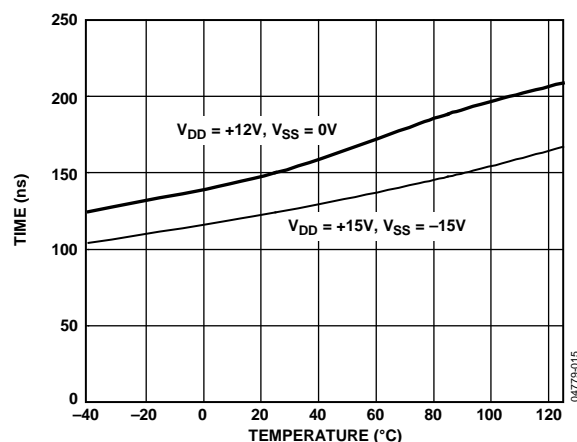


Figure 13. Transition Times vs. Temperature

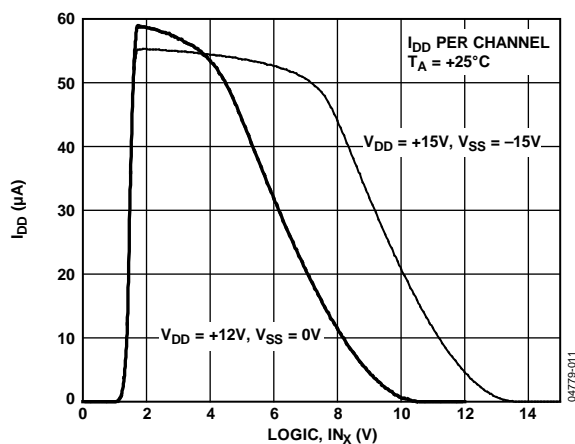
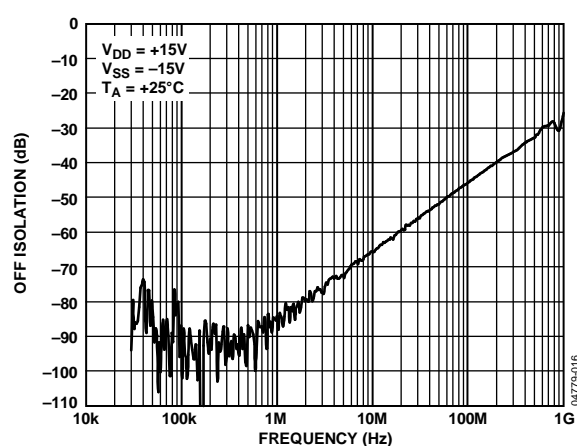
Figure 11.  $I_{DD}$  vs. Logic Level

Figure 14. Off Isolation vs. Frequency

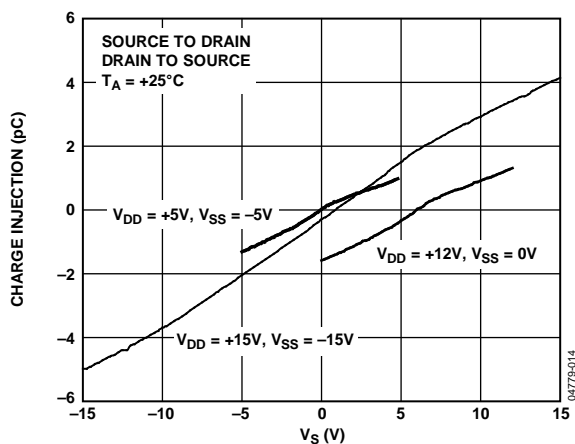


Figure 12. Charge Injection vs. Source Voltage

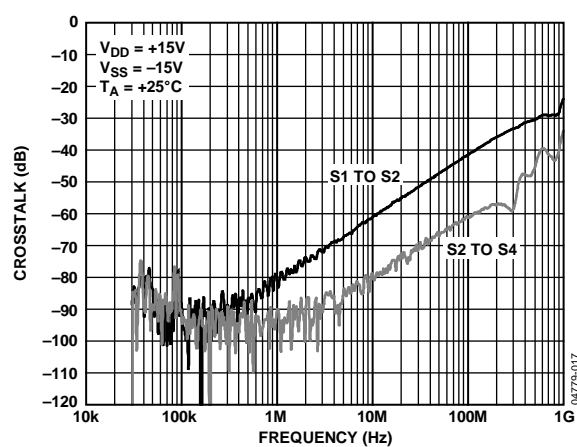


Figure 15. Crosstalk vs. Frequency

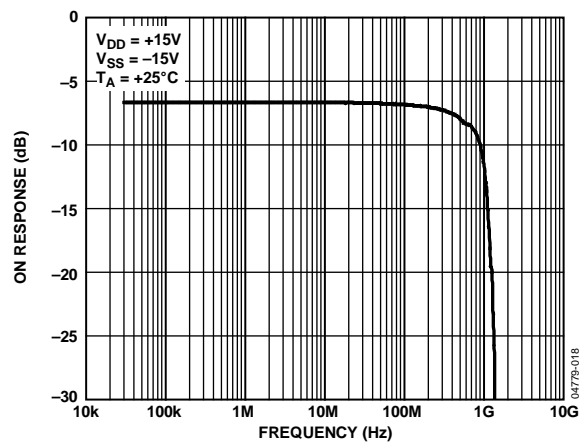


Figure 16. On Response vs. Frequency

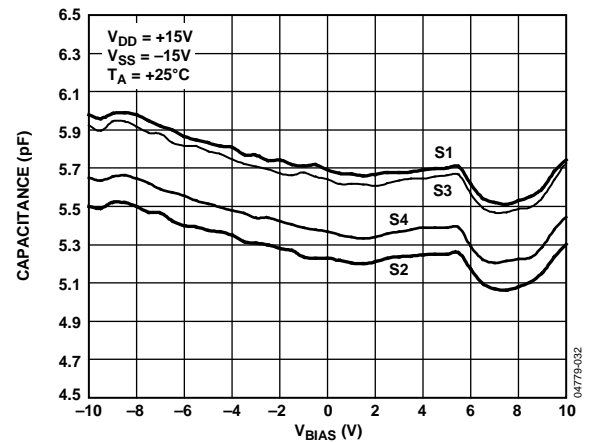


Figure 19. On Capacitance vs. Source Voltage

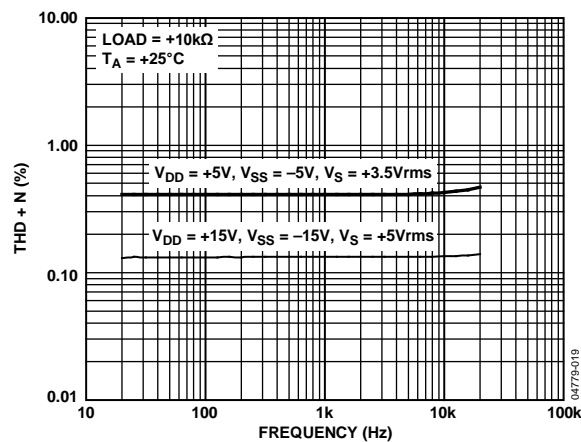


Figure 17. THD + N vs. Frequency

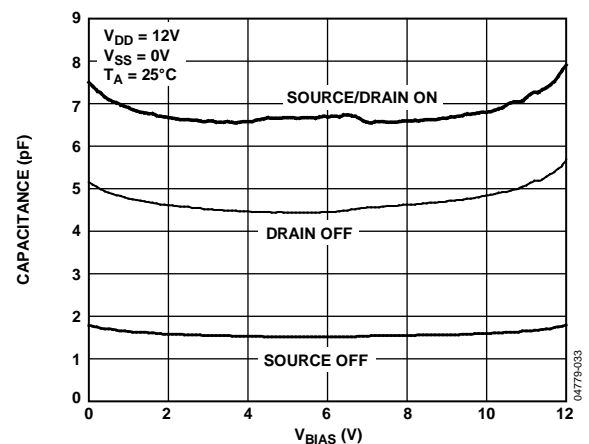


Figure 20. Capacitance vs. Source Voltage, Single Supply

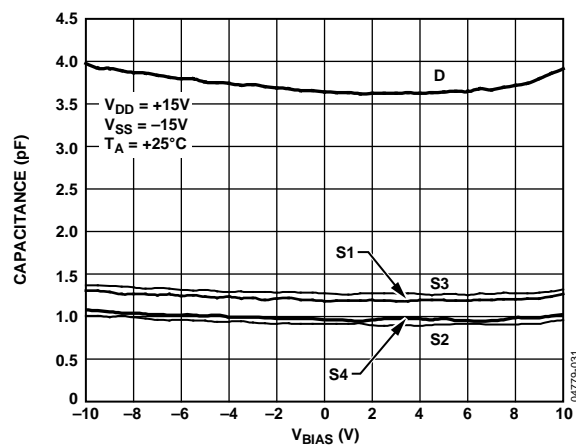


Figure 18. Off Capacitance vs. Source Voltage

## TEST CIRCUITS

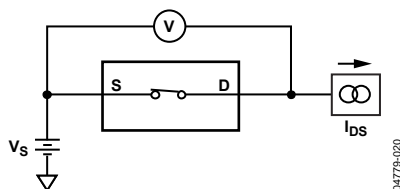


Figure 21. On Resistance

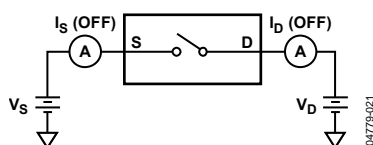


Figure 22. Off Leakage

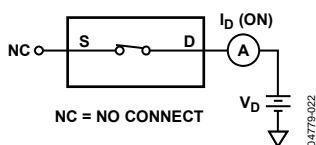


Figure 23. On Leakage

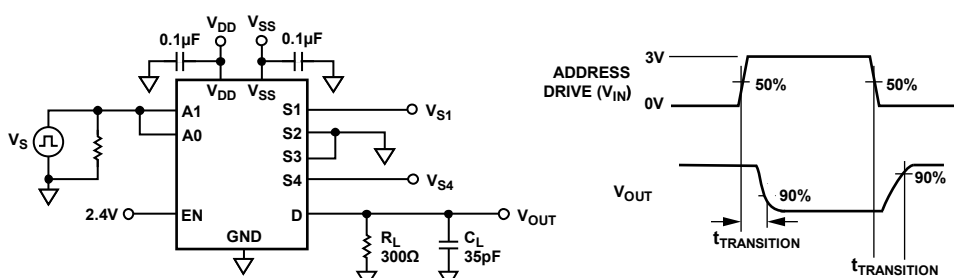


Figure 24. Address to Output Switching Times

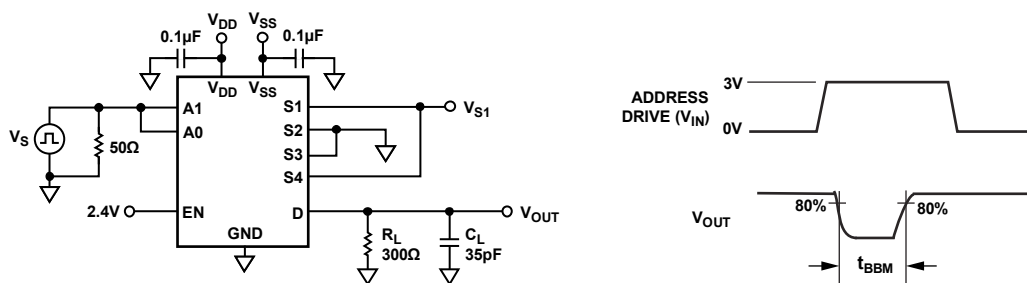


Figure 25. Break-Before-Make Time Delay

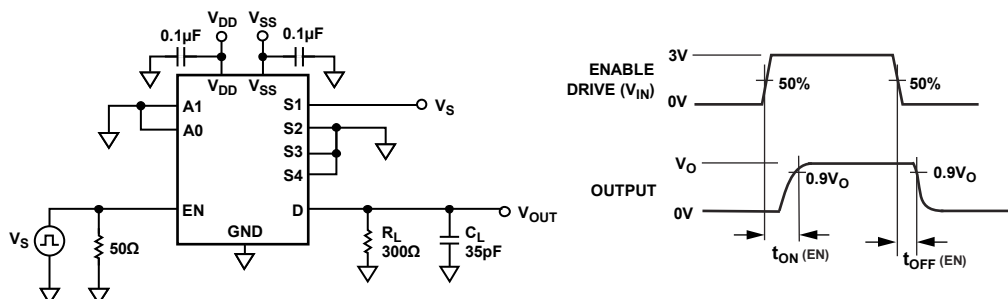
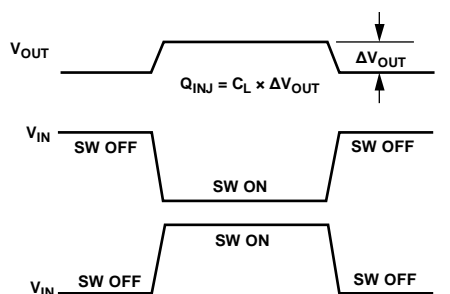
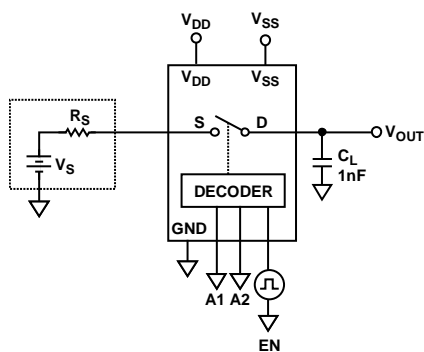
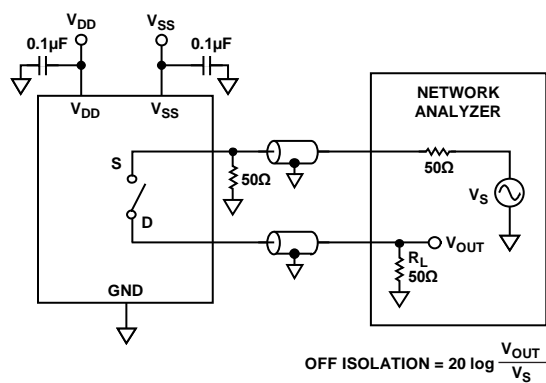


Figure 26. Enable-to-Output Switching Delay



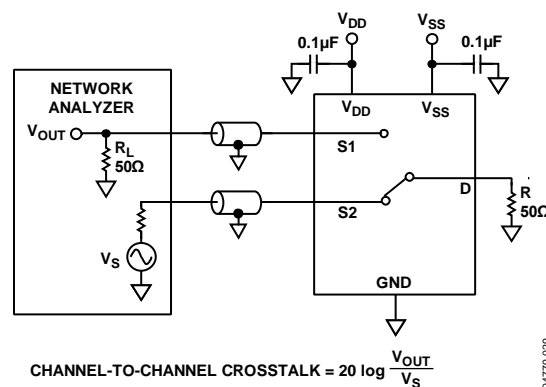
04779-028

Figure 27. Charge Injection



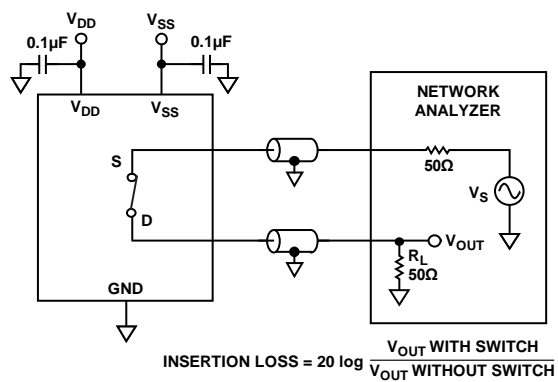
04779-027

Figure 28. Off Isolation



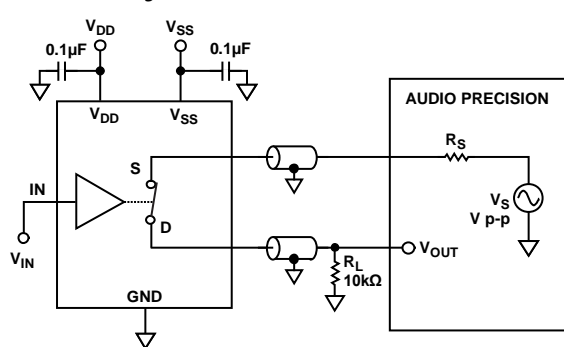
04779-029

Figure 30. Channel-to-Channel Crosstalk



04779-028

Figure 29. Bandwidth



04779-030

Figure 31. THD + Noise

## TERMINOLOGY

### **I<sub>DD</sub>**

The positive supply current.

### **I<sub>SS</sub>**

The negative supply current.

### **V<sub>D</sub> (V<sub>S</sub>)**

The analog voltage on Terminal D and Terminal S.

### **R<sub>ON</sub>**

The ohmic resistance between D and S.

### **R<sub>FLAT(ON)</sub>**

Flatness is defined as the difference between the maximum and minimum value of on resistance, as measured over the specified analog signal range.

### **I<sub>S</sub> (OFF)**

The source leakage current with the switch off.

### **I<sub>D</sub> (OFF)**

The drain leakage current with the switch off.

### **I<sub>D</sub>, I<sub>S</sub> (ON)**

The channel leakage current with the switch on.

### **V<sub>INL</sub>**

The maximum input voltage for Logic 0.

### **V<sub>INH</sub>**

The minimum input voltage for Logic 1.

### **I<sub>INL</sub> (I<sub>INH</sub>)**

The input current of the digital input.

### **C<sub>S</sub> (OFF)**

The off switch source capacitance, which is measured with reference to ground.

### **C<sub>D</sub> (OFF)**

The off switch drain capacitance, which is measured with reference to ground.

### **C<sub>D</sub>, C<sub>S</sub> (On)**

The on switch capacitance, measured with reference to ground.

### **C<sub>IN</sub>**

The digital input capacitance.

### **t<sub>ON</sub> (EN)**

The delay between applying the digital control input and the output switching on.

### **t<sub>OFF</sub> (EN)**

The delay between applying the digital control input and the output switching off.

### **t<sub>TRANS</sub>**

The delay time between the 50% and 90% points of the digital input and switch on condition when switching from one address state to another.

### **Charge Injection**

A measure of the glitch impulse transferred from the digital input to the analog output during switching.

### **Off Isolation**

A measure of unwanted signal coupling through an off switch.

### **Crosstalk**

A measure of unwanted signal that is coupled through from one channel to another as a result of parasitic capacitance.

### **Bandwidth**

The frequency at which the output is attenuated by –3 dB.

### **On Response**

The frequency response of the on switch.

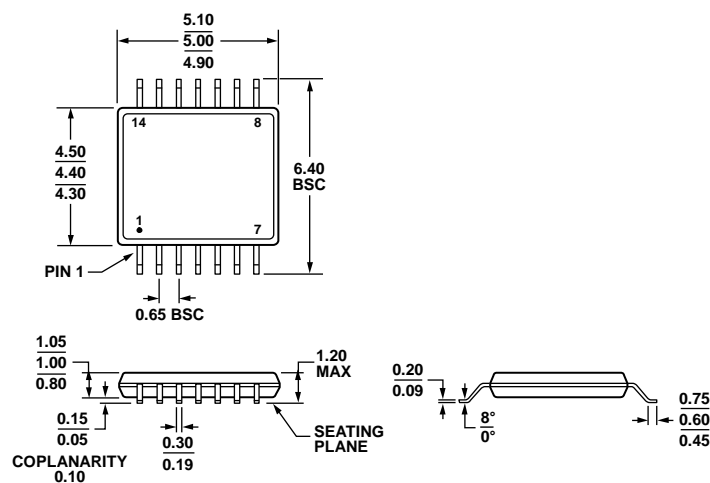
### **Insertion Loss**

The loss due to the on resistance of the switch.

### **Total Harmonic Distortion + Noise (THD + N)**

The ratio of the harmonic amplitude plus noise of the signal to the fundamental.

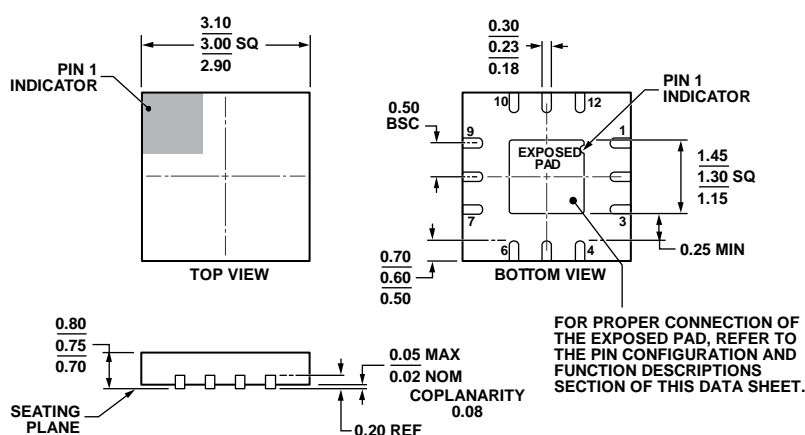
## OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MO-153-AB-1

Figure 32. 14-Lead Thin Shrink Small Outline Package [TSSOP]  
(RU-14)

Dimensions shown in millimeters



COMPLIANT TO JEDEC STANDARDS MO-220-WEED.

Figure 33. 12-Lead Lead Frame Chip Scale Package [LFCSP]  
3 mm × 3 mm Body and 0.75 mm Package Height  
(CP-12-4)

Dimensions shown in millimeters

## ORDERING GUIDE

| Model <sup>1</sup> | Temperature Range | Package Description                               | Package Option |
|--------------------|-------------------|---|----------------|
| ADG1204YRUZ        | −40°C to +125°C   | 14-Lead Thin Shrink Small Outline Package [TSSOP] | RU-14          |
| ADG1204YRUZ-REEL   | −40°C to +125°C   | 14-Lead Thin Shrink Small Outline Package [TSSOP] | RU-14          |
| ADG1204YRUZ-REEL7  | −40°C to +125°C   | 14-Lead Thin Shrink Small Outline Package [TSSOP] | RU-14          |
| ADG1204YCPZ-500RL7 | −40°C to +125°C   | 12-Lead Lead Frame Chip Scale Package [LFCSP]     | CP-12-4        |
| ADG1204YCPZ-REEL7  | −40°C to +125°C   | 12-Lead Lead Frame Chip Scale Package [LFCSP]     | CP-12-4        |

<sup>1</sup> Z = RoHS Compliant Part.

**NOTES**